<u>S/N 10/612,834</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ashay A. Dani et al. Examiner: Terrell L Mckinnon

 Serial No.: 10/612,834
 Group Art Unit: 3753

 Filed: June 30, 2003
 Docket No.: 884.945US1

Title: HEAT DISSIPATING DEVICE WITH PRESELECTED DESIGNED INTERFACE FOR THERMAL INTERFACE MATERIALS

Assignee: Intel Corporation Customer Number: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on <u>December 1, 2005</u>. Please amend the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a one-month extension of the period for responding to the Office action, thereby moving the deadline for response from March 1, 2006 to April 1, 2006.